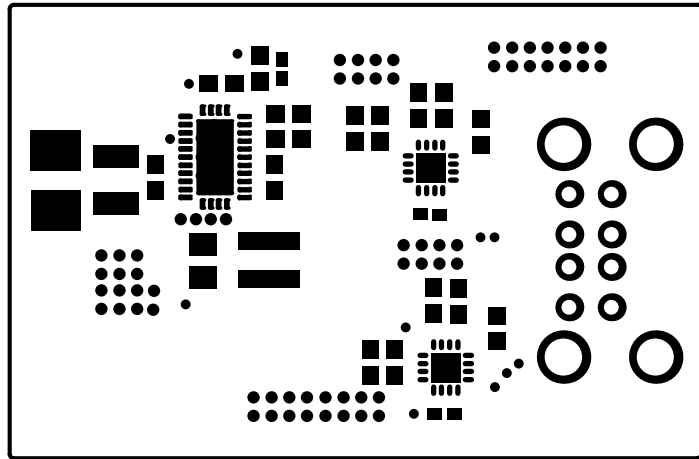
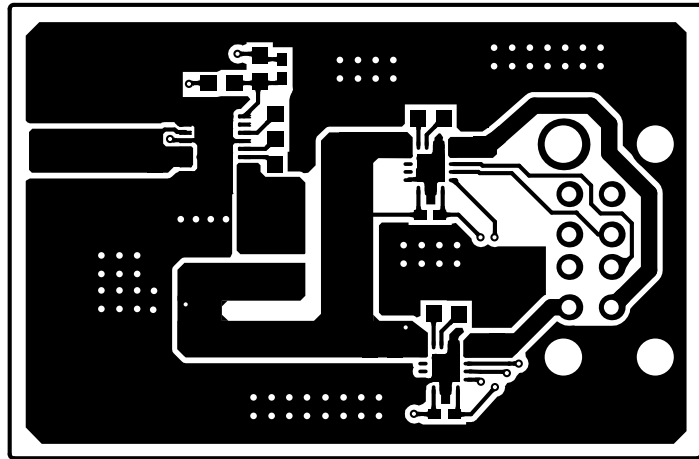


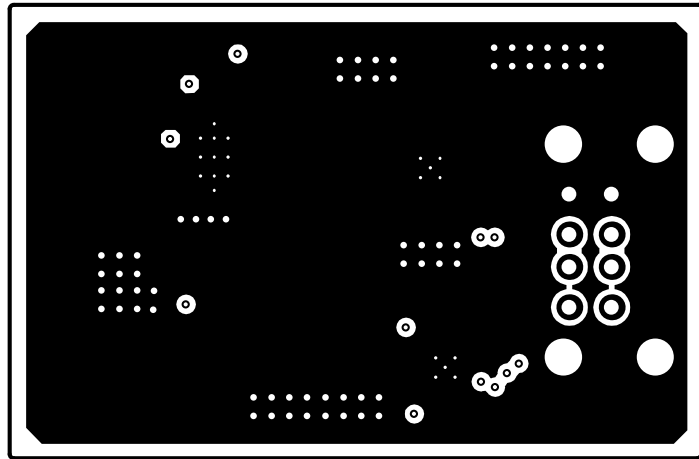
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Top Overlay	GENERATED : 5/27/2016	5:29:46 PM	TEXAS INSTRUMENTS



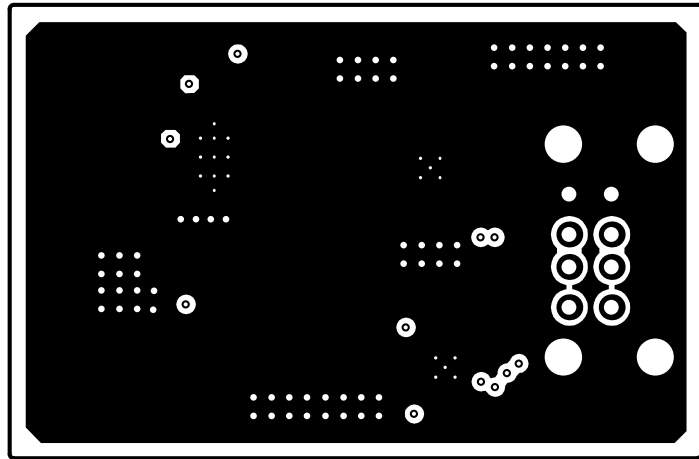
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Top Solder Mask	GENERATED : 5/27/2016 5:29:47 PM		TEXAS INSTRUMENTS



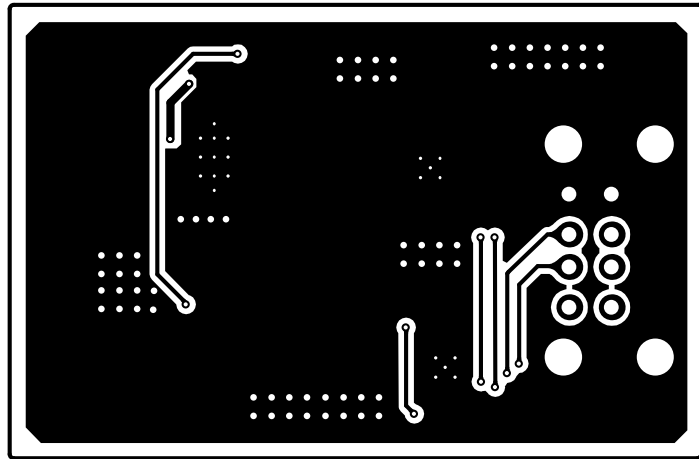
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Top Layer	GENERATED : 5/27/2016 5:29:48 PM		TEXAS INSTRUMENTS



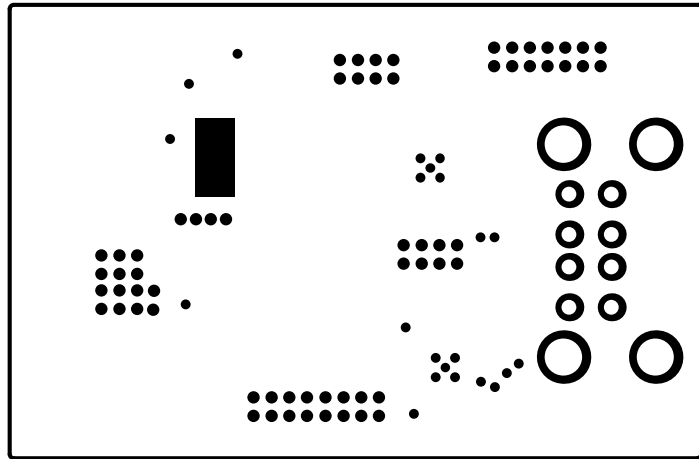
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Signal Layer 1	GENERATED : 5/27/2016 5:29:49 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Signal Layer 2	GENERATED : 5/27/2016 5:29:50 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Bottom Layer	GENERATED : 5/27/2016 5:29:51 PM		TEXAS INSTRUMENTS

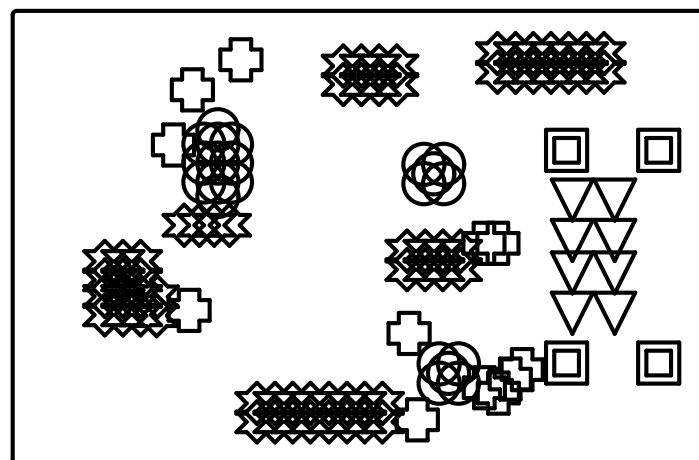


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Bottom Solder Mask	GENERATED : 5/27/2016 5:29:52 PM		TEXAS INSTRUMENTS

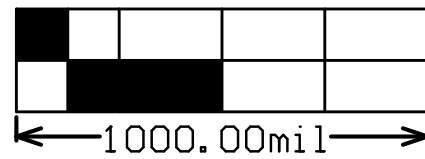
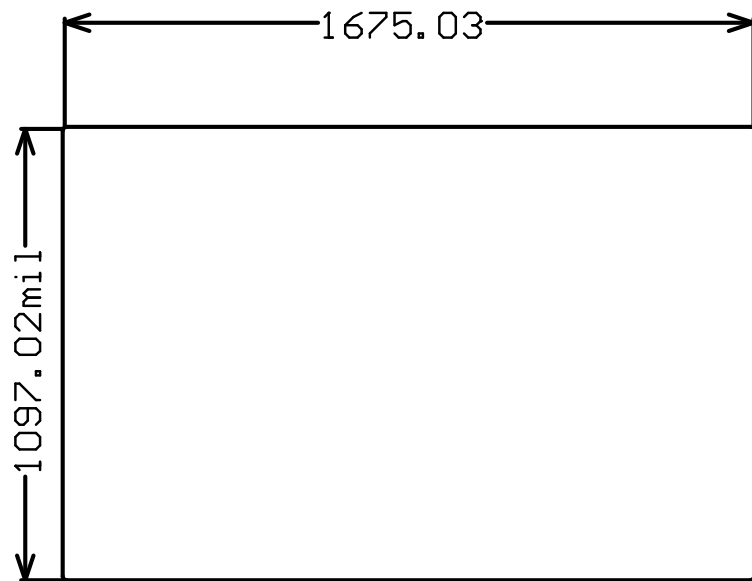


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP11670		
PLOT NAME = Bottom Overlay	GENERATED : 5/27/2016 5:29:53 PM		TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	21	7.87mil (0.200mm)	PTH	Round
⊕	12	10.00mil (0.254mm)	PTH	Round
⊗	64	16.00mil (0.406mm)	PTH	Round
▽	8	36.00mil (0.914mm)	PTH	Round
■	4	90.55mil (2.300mm)	PTH	Round
	109 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP11670		
PLOT NAME = Drill Drawing	GENERATED : 5/27/2016 5:29:53 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11670	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP11670		
PLOT NAME = Board Dimensions	GENERATED : 5/27/2016 5:29:54 PM		TEXAS INSTRUMENTS

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